



eUICC SIM Datasheet

V1.1 | JULY 2020

HOLOGRAM.IO 1

Triple-cut form factor

2FF, 3FF, 4FF

Product Overview

A secure IoT SIM card for a global cell network built for M2M data with easy activation, transparent pricing, and developer-friendly tools.

Orderable part numbers

 SIM-E-TRI-GL
 SIM-E-TRI-LS

 SIM-E-TRI-GL-10
 SIM-E-TRI-LS-10

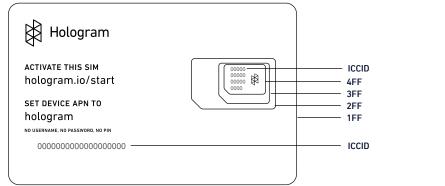
 SIM-E-TRI-GL-100
 SIM-E-TRI-LS-100

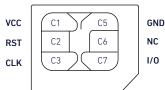
 SIM-E-TRI-GL-1000
 SIM-E-TRI-LS-1000

Network Availability

Works globally with Hologram's 2G through LTE network where coverage is available. More information: https://www.hologram.io/pricing/coverage

Mechanical specifications





Size

1FF	Full-size	85.5 x 53.98 x 0.76 mm
2FF	Mini-SIM	25 x 15 x 0.76 mm
3FF	Micro-SIM	15 x 12 x 0.76 mm
4FF	Mini-SIM	12.3 x 8.8 x 0.76 mm

Pin Definitions

C1	VCC	Input Voltage
C2	RST	Reset
С3	CLK	Clock
C5	GND	Ground
C6	NC	No Connect
C7	1/0	Input/Output



Hardware Specifications

Environmental	Standard Grade	Industrial Grade
Temperature	-25-85°C	-40-105°C
Lifespan	25 years @ 25°C	15 years @ 85°C
Lifespan	100K read/write cycles	500K read/write cycles
Electrical	Standard Grade	Industrial Grade
Operating Voltage	1.62V-5.5V	1.62V-5.5V

AC electrical parameters standards

ETSI 3GPP TS 102 221(UICC Terminal Interface Physical & Logical Characteristics)
ETSI TS 102 671 v9.1.0(M2M Physical and Logical Characteristics)
ISO 7816-3 standard for (Cards with Contacts - Electrical interface and transmission protocols)

Compliance

Chip	Common Criteria	EAL: PP-0084/35
OS	GSMA.	SGP.11 RSP v3.1; SGP.14 eUICC PKI v1.1; SGP.02 v3.2 ; SGP.05 eUICC PP-0089
	sim alliance	eUICC Profile Package v2.1
	GLOBALPLATFORM®	Product Qualification
Production	Security Accreditation Scheme	SAS-UP eUICC : EUM
Remote SIM provisioning	GSMA.	SGP.01 RSP v1.1 ; SGP.11 RSP v3.1 & 3.2; SGP.14 eUICC PKI v1.1 ; SAS-SM

RoHS and REACH Compliance

Hologram, Inc. hereby declares that the aforementioned Hologram products, placed on the European Community market by the Company and its subsidiaries is compliant with Directive 2011/65/EU on the Restriction of Certain Hazardous Substances in Electrical and Electronic Equipment.

More information: https://www.samsung.com/semiconductor/about-us/global-compliance/



Embedded form factor

MFF2, QFN8

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 SIM-E-MFF2-GL
 SIM-E-MFF2-LS

 SIM-E-MFF2-GL-10
 SIM-E-MFF2-LS-10

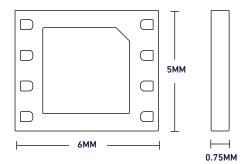
 SIM-E-MFF2-GL-100
 SIM-E-MFF2-LS-100

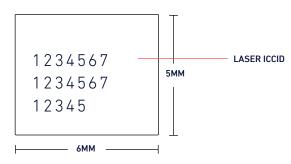
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Mechanical specifications

Bottom View

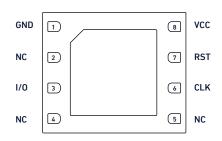




Pin Definitions

1	GND	Ground
2	NC	No Connect
3	1/0	Input/Output
4	NC	No Connect
5	NC	No Connect
6	CLK	Clock
7	RST	Reset
8	VCC	Input Voltage

Top View



Size

6 x 5 x 0.75mm

Hardware Specifications

Environmental	Standard Grade	Industrial Grade
Temperature	-25-85°C	-40-105°C
Lifespan	25 years @ 25°C	15 years @ 85°C
Lifespan	100K read/write cycles	500K read/write cycles
Electrical	Standard Grade	Industrial Grade
Operating Voltage	1.62V-5.5V	1.62V-5.5V

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	GLOBALPLATFORM°	Product Qualification
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Remote SIM provisioning	csma.	SGP.01 RSP v1.1 ; SGP.11 RSP v3.1 & 3.2; SGP.14 eUICC PKI v1.1 ; SAS-SM

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